

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5946803

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
AKIRA YASUDA	08/08/2011
JUNICHI OKAMURA	08/08/2011
RECEIVING PARTY DATA	
Name:	TRIGENCE SEMICONDUCTOR, INC.
Street Address:	6 FLOOR, SHIN HITOKUCHIZAKA BLD., HOSEI UNIV., 3-3-9, KUDANKITA, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1020073
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	9681231
CORRESPONDENCE DATA	
Fax Number:	(703)518-5499
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7036841111
Email:	docketing@ipfirm.com, yshgroup@ipfirm.com
Correspondent Name:	HAUPTMAN HAM, LLP
Address Line 1:	2318 MILL ROAD
Address Line 2:	SUITE 1400
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	5725-0131CON2
NAME OF SUBMITTER:	YOON S. HAM
SIGNATURE:	/Yoon S. Ham/
DATE SIGNED:	02/04/2020
Total Attachments: 1	
source=F-5725-0131CON2_AssignmentFrm12285323#page1.tif	

N00623550S

U.S. PTO
12/285323
10/01/2008

Attorney Docket No.: 2124.1001

U.S. ASSIGNMENT

SAH 100

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))

Trigence Semiconductor, Inc.
6 floor, Shin Hitokuchizaka Bld.,
HOSEI Univ., 3-3-9, Kudankita,
Chiyoda-ku, Tokyo, 1020073 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

DIGITAL/ANALOGUE CONVERSION APPARTUS

relating to International Patent Application PCT/JP2007/080072 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on October 1, 2008,
Serial No. _____;

Any registered attorney of STAAS & HALSEY LLP, 1201 New York Avenue, N.W., Suite 700 Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).
(Typed Name & Signature of Inventor(s)) (Date) (Typed Name & Signature of Witness(es))

- 1) Akira Yasuda 08. Aug '11
- 2) Junichi Okamura 08. Aug 11
- 3) _____
- 4) _____